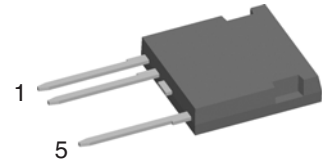
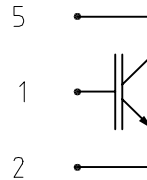


# High Voltage BIMOSFET™

in High Voltage ISOPLUS i4-PAC™

Monolithic Bipolar MOS Transistor



$$I_{C25} = 28 \text{ A}$$

$$V_{CES} = 1600 \text{ V}$$

$$V_{CE(sat)} = 6.2 \text{ V}$$

$$t_f = 40 \text{ ns}$$

IGBT			
Symbol	Conditions	Maximum Ratings	
$V_{CES}$	$T_{VJ} = 25^\circ\text{C to } 150^\circ\text{C}$	1600	V
$V_{GES}$		$\pm 20$	V
$I_{C25}$	$T_C = 25^\circ\text{C}$	28	A
$I_{C90}$	$T_C = 90^\circ\text{C}$	16	A
$I_{CM}$ $V_{CEK}$	$V_{GE} = 15/0 \text{ V}; R_G = 22 \Omega; T_{VJ} = 125^\circ\text{C}$ RBSOA, Clamped inductive load; $L = 100 \mu\text{H}$	40	A
		$0.8V_{CES}$	
$P_{tot}$	$T_C = 25^\circ\text{C}$	250	W

### Features

- High Voltage BIMOSFET™
  - substitute for high voltage MOSFETs with significantly lower voltage drop
  - fast switching for high frequency operation
  - reverse conduction capability
- ISOPLUS i4-PAC™ high voltage package
  - isolated back surface
  - enlarged creepage towards heatsink
  - enlarged creepage between high voltage pins
  - application friendly pinout
  - high reliability
  - industry standard outline

Symbol	Conditions	Characteristic Values ( $T_{VJ} = 25^\circ\text{C}$ , unless otherwise specified)			
		min.	typ.	max.	
$V_{CE(sat)}$	$I_C = 20 \text{ A}; V_{GE} = 15 \text{ V}; T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$		6.2 6.9	7.1 V	
$V_{GE(th)}$	$I_C = 2 \text{ mA}; V_{GE} = V_{CE}$	4		8 V	
$I_{CES}$	$V_{CE} = 0.8V_{CES}; V_{GE} = 0 \text{ V}; T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$		0.8	0.4 mA mA	
$I_{GES}$	$V_{CE} = 0 \text{ V}; V_{GE} = \pm 20 \text{ V}$			500 nA	
$t_{d(on)}$ $t_r$ $t_{d(off)}$ $t_f$	Inductive load, $T_{VJ} = 125^\circ\text{C}$ $V_{CE} = 960 \text{ V}; I_C = 25 \text{ A}$ $V_{GE} = 15/0 \text{ V}; R_G = 22 \Omega$		200 60 300 40	ns ns ns ns	
$C_{ies}$		$V_{CE} = 25 \text{ V}; V_{GE} = 0 \text{ V}; f = 1 \text{ MHz}$		3300	pF
$Q_{Gon}$		$V_{CE} = 600 \text{ V}; V_{GE} = 15 \text{ V}; I_C = 20 \text{ A}$		130	nC
$V_F$		(reverse conduction); $I_F = 20 \text{ A}$		2.5	V
$R_{thJC}$				0.5 K/W	

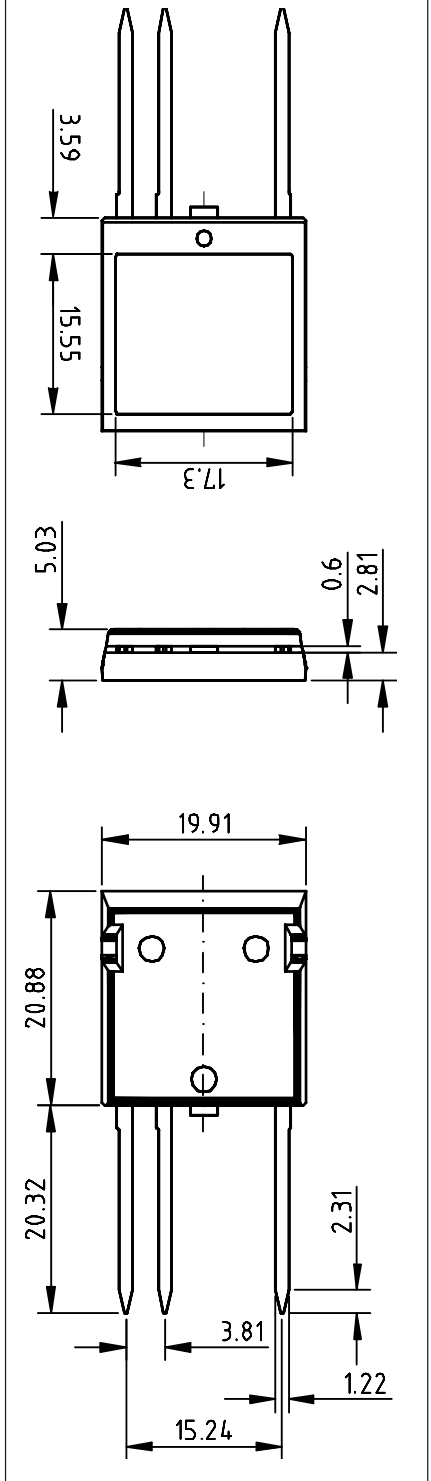
### Applications

- switched mode power supplies
- DC-DC converters
- resonant converters
- lamp ballasts
- laser generators, x ray generators

**Component**

Symbol	Conditions	Maximum Ratings	
$T_{VJ}$		-55...+150	°C
$T_{stg}$		-55...+125	°C
$V_{ISOL}$	$I_{ISOL} \leq 1 \text{ mA}; 50/60 \text{ Hz}$	2500	V~
$F_c$	mounting force with clip	20...120	N

Symbol	Conditions	Characteristic Values		
		min.	typ.	max.
$d_s, d_A$	C pin - E pin	7		mm
$d_s, d_A$	pin - backside metal	5.5		mm
$R_{thCH}$	with heatsink compound		0.15	K/W
<b>Weight</b>			9	g

**Dimensions in mm (1 mm = 0.0394")**


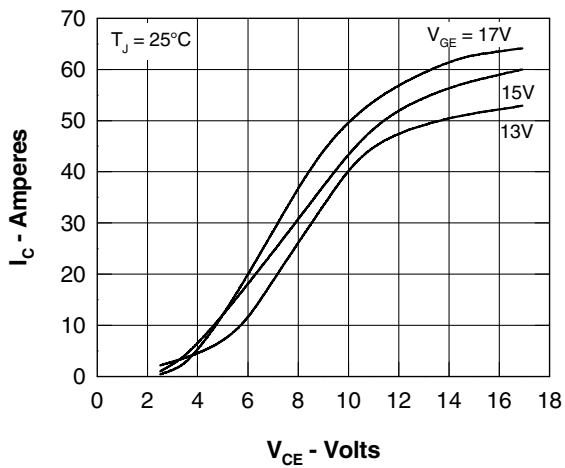


Fig. 1 Typ. Output Characteristics

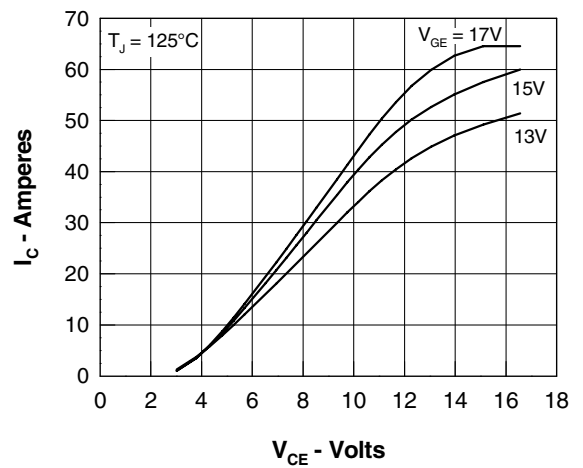


Fig. 2 Typ. Output Characteristics

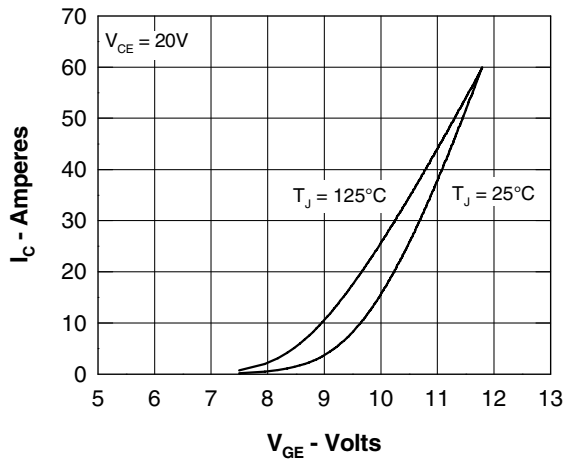


Fig. 3 Typ. Transfer Characteristics

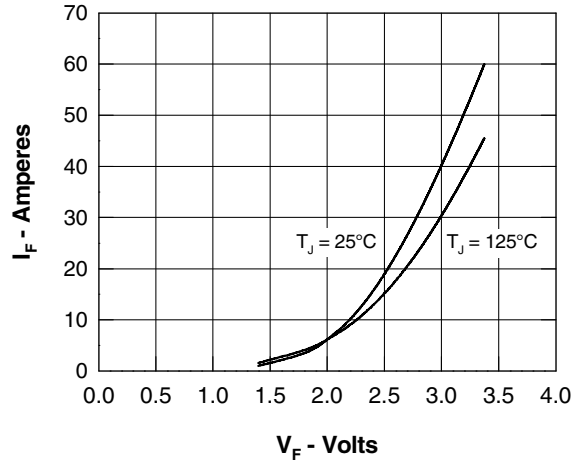


Fig. 4 Typ. Characteristics of Reverse Conduction

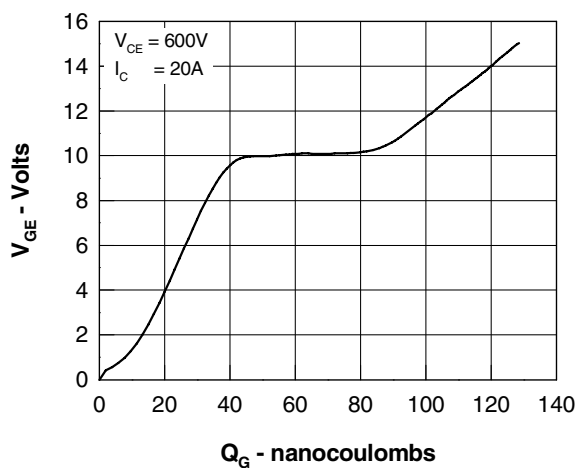


Fig. 5 Typ. Gate Charge characteristics

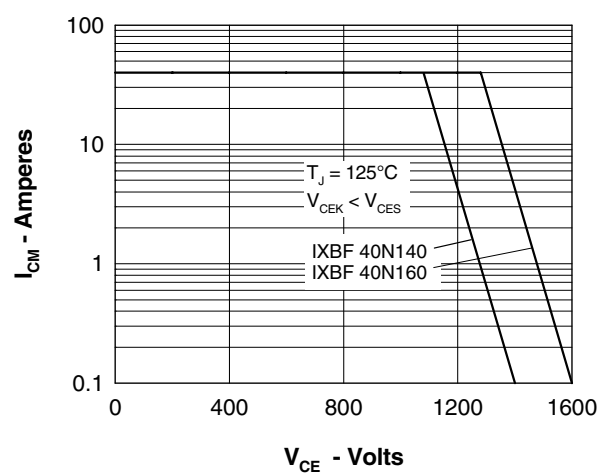


Fig. 6 Reverse Based Safe Operating Area RBSOA

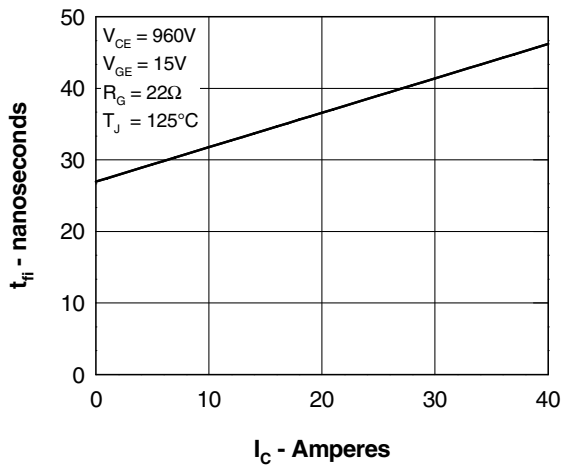


Fig. 7 Typ. Fall Time

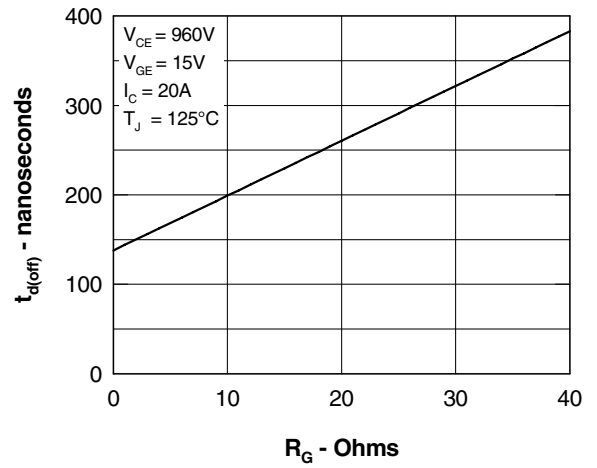


Fig. 8 Typ. Turn Off Delay Time

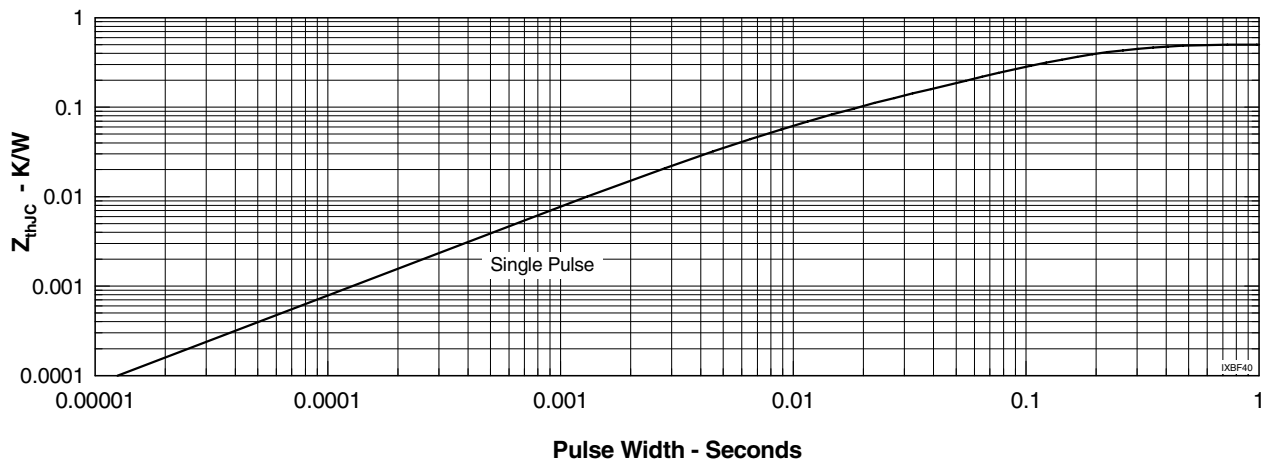


Fig. 9 Typ. Transient Thermal Impedance

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